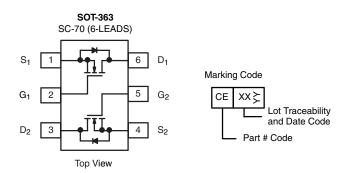


**Vishay Siliconix** 

## Dual N-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	<b>R<sub>DS(on)</sub> (</b> Ω <b>)</b>	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)		
30	0.190 at V <sub>GS</sub> = 10 V	1.3	0.91 nC		
	0.344 at V <sub>GS</sub> = 4.5 V	1.3	0.91110		

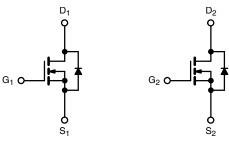


#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 ٠ Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>g</sub> Tested •
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

Load Switch for Portable Applications



N-Channel MOSFET

N-Channel MOSFET

**Ordering Information:** 

Si1972DH-T1-E3 (Lead (Pb)-free) Si1972DH-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	30	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		1.3 <sup>a</sup>		
Continuous Drain Current (T = $150 ^{\circ}$ C)	T <sub>C</sub> = 70 °C		1.3 <sup>a</sup>		
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	1.3 <sup>a</sup>		
	T <sub>A</sub> = 70 °C		1.2	A	
Pulsed Drain Current		I <sub>DM</sub>	4		
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	1-	1		
	T <sub>A</sub> = 25 °C	I <sub>S</sub>	0.61 <sup>c</sup>		
	T <sub>C</sub> = 25 °C		1.25		
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	PD	0.8	w	
	T <sub>A</sub> = 25 °C	ГD	0.74 <sup>b, c</sup>	~~~~	
	T <sub>A</sub> = 70 °C		0.47 <sup>b, c</sup>		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>b, f</sup>	$t \le 5 s$	R <sub>thJA</sub>	130	170	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	80	100	0/11	

Notes: a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. Maximum under steady state conditions is 220 °C/W.

Document Number: 74398 S12-0335-Rev. C, 13-Feb-12 www.vishay.com



COMPLIANT

HALOGEN

FREE



# Si1972DH

### Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		·			•		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	ΔV <sub>DS</sub> /T <sub>J</sub>		23.5			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA		- 4.6		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1.5		2.8	V	
Gate-Source Leakage	$I_{GSS}$ $V_{DS} = 0 V, V_{GS} = \pm 20 V$				± 100	ns	
Zana Oata Maltana Durin Ourset	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	- μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	4			A	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 1.3 A		0.155	0.225	Ω	
		V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 0.29 A		0.278	0.340		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 1.3 A		1.4		S	
Dynamic <sup>b</sup>							
Input Capacitance	C <sub>iss</sub>			75		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		18			
Reverse Transfer Capacitance	C <sub>rss</sub>			6			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 1.3 \text{ A}$		1.85	2.8	nC	
				0.91	1.4		
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> = 15 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 1.3 A		0.51			
Gate-Drain Charge	Q <sub>gd</sub>			0.3			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.9	4.5	9	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			15	25	- ns	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = 15 V, R <sub>I</sub> = 12.5 Ω		50	75		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 1.2 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		7	15		
Fall Time	t <sub>f</sub>			15	25		
Turn-on Delay Time	t <sub>d(on)</sub>			5	10		
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, R <sub>L</sub> = 12.5 $\Omega$		10	15		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong 1.2 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		10	15		
Fall Time	t <sub>r</sub>	1 1		6	12		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	T <sub>C</sub> = 25 °C			1	A	
Pulse Diode Forward Current	I <sub>SM</sub>			1	4		
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 1.2 A, V <sub>GS</sub> = 0 V		0.85	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			20	40	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			18	36	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = 1.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 ^\circ\text{C}$		16			
Reverse Recovery Rise Time	t <sub>b</sub>			4		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

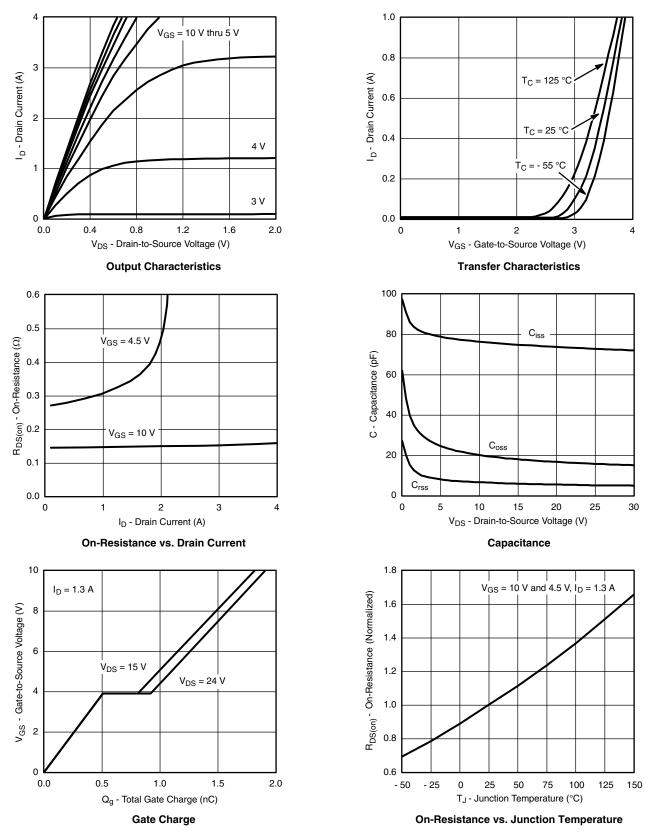
b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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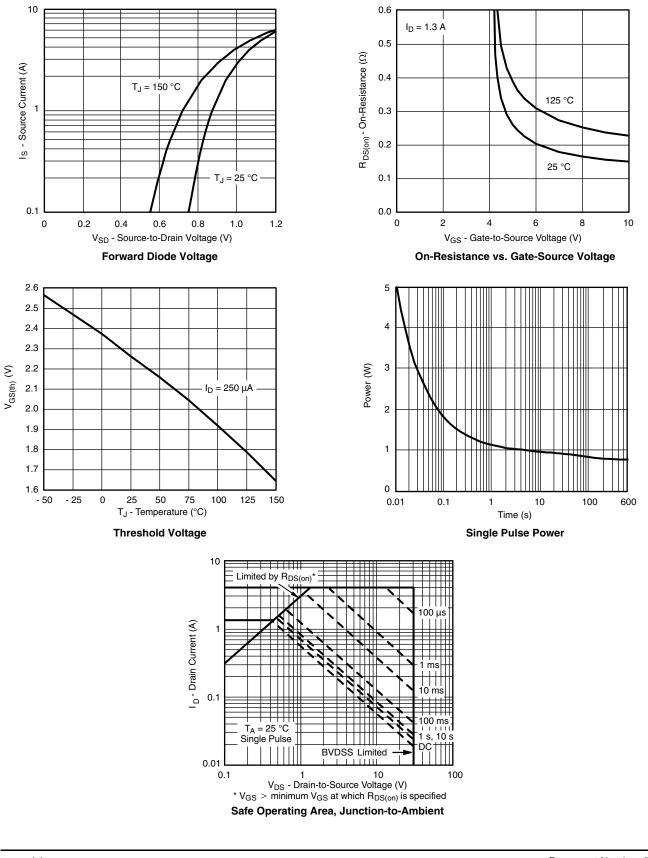
3

# Si1972DH



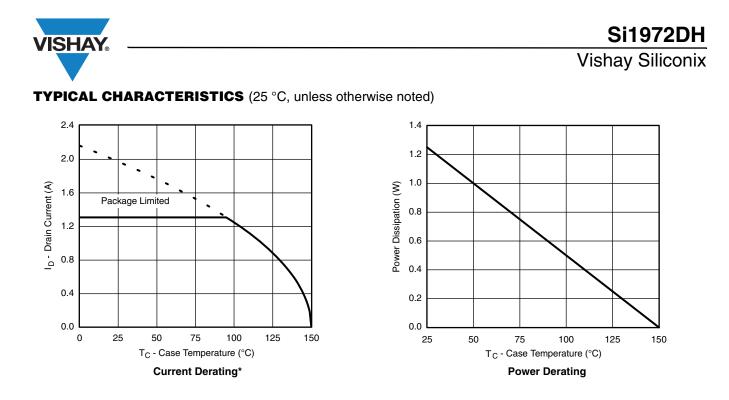
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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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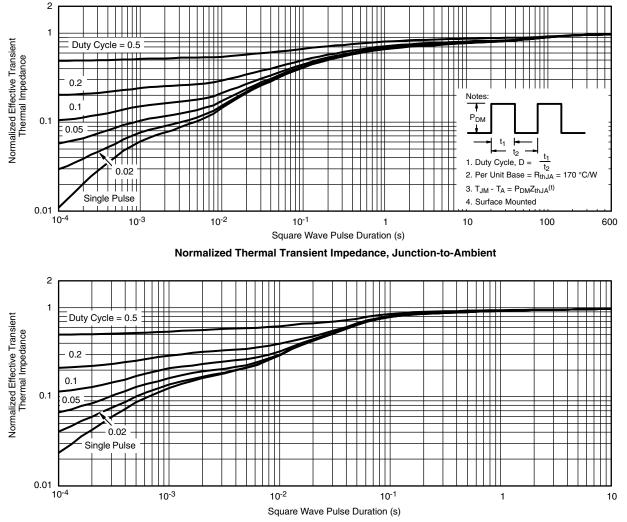
\* The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

5

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#### TYPICAL CHARACTERISTICS (25 °C, unless otherwiese noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?74398">www.vishay.com/ppg?74398</a>.

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